## **MAU2111**

## Silicon epitaxial planar type

For high speed switching circuits

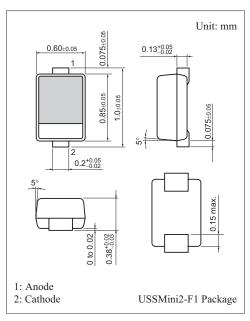
#### ■ Features

- Optimum for high-density mounting
- Short reverse recovery time t<sub>rr</sub>
- Small terminal capacitance C<sub>t</sub>

### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Reverse voltage	V <sub>R</sub>	80	V	
Maximum peak reverse voltage	V <sub>RM</sub>	80	V	
Forward current	$I_{\mathrm{F}}$	100	mA	
Forward current (Average)	$I_{FM}$	225	mA	
Non-repetitive peak forward surge current *	I <sub>FSM</sub>	500	mA	
Junction temperature	$T_j$	150	°C	
Storage temperature	T <sub>stg</sub>	-55 to +150	°C	





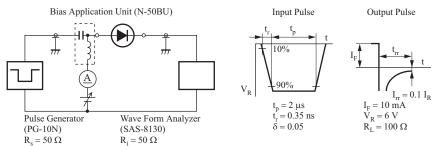
Marking Symbol: 11

### ■ Electrical Characteristics $T_a = 25$ °C±3°C

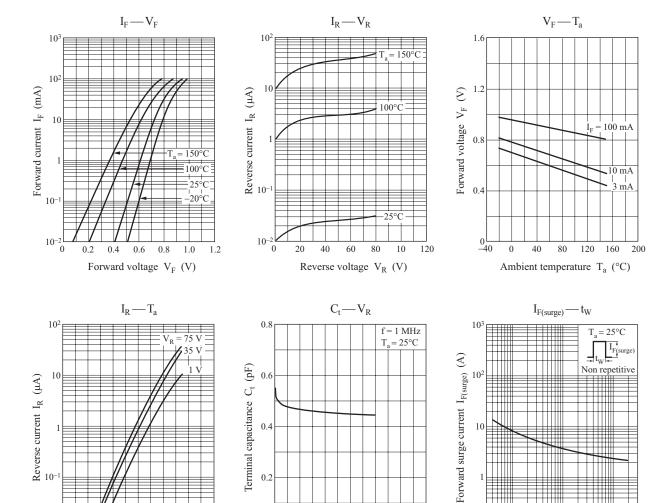
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward current	$V_{\rm F}$	$I_F = 100 \text{ mA}$		0.95	1.2	V
Reverse voltage	$V_R$	$I_R = 100 \mu A$	80			V
Reverse current	$I_R$	$V_R = 75 \text{ V}$			100	nA
Terminal capacitance	$C_{t}$	$V_R = 0$ , $f = 1$ MHz		0.6	2	pF
Reverse recovery time *	t <sub>rr</sub>	$I_F = 10 \text{ mA}, V_R = 6 \text{ V}, I_{rr} = 0.1 I_R,$ $R_L = 100 \Omega$			3.0	ns

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

- 2. Absolute frequency of input and output is 100 MHz.
- 3. \*: t<sub>rr</sub> measurement circuit



**Panasonic** MAU2111



40 60 80

Reverse voltage V<sub>R</sub> (V)

10-

Pulse width t<sub>W</sub> (ms)

0.2

10<sup>-2</sup> \_\_\_\_\_

80 120 160

Ambient temperature  $T_a$  (°C)

40

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